Data sheet acquired from Harris Semiconductor

CD54/74AC283, CD54/74ACT283

August 1998 - Revised May 2000

4-Bit Binary Fill Adder With Fast Carry

Features

- · Buffered Inputs
- Exceeds 2kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST™/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
 - Fanout to 15 FAST™ ICs
 - Drives 50Ω Transmission Lines

Description

The 'AC283 and 'ACT283 4-bit binary adders with fast carry that utilize Advanced CMOS Logic technology. These devices add two 4-bit binary numbers and generate a carry-out bit if the sum exceeds 15.

Because of the symmetry of the add function, this device can be used with either all active-HIGH operands (positive logic) or with all active-LOW operands (negative logic). When using positive logic, the carry-in input must be tied LOW if there is no carry-in.

Ordering Information

| PART NUMBER | TEMP. RANGE (^O C) | PACKAGE |
|----------------|-------------------------------------|--------------|
| CD54AC283F3A | -55 to 125 | 16 Ld CERDIP |
| CD74AC283E | 0 to 70°C, -40 to 85, -55 to 125 | 16 Ld PDIP |
| CD74AC283M | 0 to 70°C, -40 to 85, -55 to 125 | 16 Ld SOIC |
| CD54ACT283F3A | -55 to 125 | 16 Ld CERDIP |
| CD74ACT283E | 0 to 70°C, -40 to 85, -55 to 125 | 16 Ld PDIP |
| CD74ACT283M | 0 to 70°C, -40 to 85, -55 to 125 | 16 Ld SOIC |

NOTES:

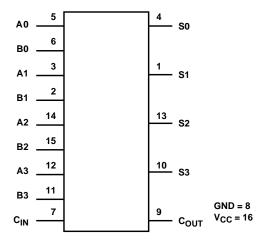
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

Pinout

(CERDIP) CD74AC283, CD74ACT283 (PDIP, SOIC) TOP VIEW 16 V_{CC} S1 1 15 B2 B1 2 14 A2 A1 3 S0 4 13 S2 12 A3 A0 5 B0 6 11 B3 10 S3 CIN 7 9 C_{OUT} GND 8

CD54AC283, CD54ACT283

Functional Diagram



CD54/74AC283, CD54/74ACT283

Absolute Maximum Ratings

| DC Supply Voltage, V _{CC} 0.5V to 6V |
|---|
| DC Input Diode Current, I _{IK} |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ ±20mA |
| DC Output Diode Current, I _{OK} |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ |
| DC Output Source or Sink Current per Output Pin, IO |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ |
| DC V _{CC} or Ground Current, I _{CC or} I _{GND} (Note 3) ±100mA |

Thermal Information

| Thermal Impedance (Typical, Note 5) | θ_{JA} (oC/W) |
|--|-----------------------|
| PDIP Package | . 67 ⁰ C/W |
| SOIC Package | . 73 ⁰ C/W |
| Maximum Junction Temperature (Plastic Package) | 150 ⁰ C |
| Maximum Storage Temperature Range | 65°C to 150°C |
| Maximum Lead Temperature (Soldering 10s) | 300°C |
| | |

Operating Conditions

| Temperature Range, T _A 55°C to 125°C |
|---|
| Supply Voltage Range, V _{CC} (Note 4) |
| AC Types1.5V to 5.5V |
| ACT Types |
| DC Input or Output Voltage, V _I , V _O |
| Input Rise and Fall Slew Rate, dt/dv |
| AC Types, 1.5V to 3V 50ns (Max) |
| AC Types, 3.6V to 5.5V |
| ACT Types, 4.5V to 5.5V |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 3. For up to 4 outputs per device, add $\pm 25 \text{mA}$ for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. The package thermal impedance is calculated in accordance with JESD 51.

DC Electrical Specifications

| | | | ST ITIONS | v _{cc} | 25°C | | -40°C TO 85°C | | -55°C TO 125°C | | |
|---------------------------|-----------------|------------------------------------|---------------------|-----------------|------|------|------------------|------|-------------------|------|-------|
| PARAMETER | SYMBOL | V _I (V) | I _O (mA) | (V) | MIN | MAX | MIN | MAX | MIN | MAX | UNITS |
| AC TYPES | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 1.5 | 1.2 | - | 1.2 | - | 1.2 | - | V |
| | | | | 3 | 2.1 | - | 2.1 | - | 2.1 | - | V |
| | | | | 5.5 | 3.85 | - | 3.85 | - | 3.85 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 1.5 | - | 0.3 | - | 0.3 | - | 0.3 | V |
| | | | | 3 | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | | | | 5.5 | - | 1.65 | - | 1.65 | - | 1.65 | V |
| High Level Output Voltage | Voн | V _{IH} or V _{IL} | -0.05 | 1.5 | 1.4 | - | 1.4 | - | 1.4 | - | V |
| | | | -0.05 | 3 | 2.9 | - | 2.9 | - | 2.9 | - | V |
| | | | -0.05 | 4.5 | 4.4 | - | 4.4 | - | 4.4 | - | V |
| | | | -4 | 3 | 2.58 | - | 2.48 | - | 2.4 | - | V |
| | | | -24 | 4.5 | 3.94 | - | 3.8 | - | 3.7 | - | V |
| | | | -75 (Note 6, 7) | 5.5 | - | - | 3.85 | - | - | - | V |
| | | | -50 (Note 6, 7) | 5.5 | - | - | - | - | 3.85 | - | V |

CD54/74AC283, CD54/74ACT283

DC Electrical Specifications (Continued)

| | | | ST ITIONS | v _{cc} | 25 | °C | | C TO °C | | C TO 5°C | |
|---|------------------|------------------------------------|---------------------|-----------------|------|------|------|------------|------|-------------|-------|
| PARAMETER | SYMBOL | V _I (V) | I _O (mA) | (V) | MIN | MAX | MIN | MAX | MIN | MAX | UNITS |
| Low Level Output Voltage | V_{OL} | V _{IH} or V _{IL} | 0.05 | 1.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.05 | 3 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.05 | 4.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 12 | 3 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 24 | 4.5 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 75 (Note 6, 7) | 5.5 | - | - | - | 1.65 | - | - | V |
| | | | 50 (Note 6, 7) | 5.5 | - | - | - | - | - | 1.65 | V |
| Input Leakage Current | IĮ | V _{CC} or GND | - | 5.5 | - | ±0.1 | - | ±1 | - | ±1 | μА |
| Quiescent Supply Current MSI | I _{CC} | V _{CC} or GND | 0 | 5.5 | - | 8 | - | 80 | - | 160 | μА |
| ACT TYPES | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 4.5 to 5.5 | 2 | - | 2 | - | 2 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 4.5 to 5.5 | - | 0.8 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage | V _{OH} | V _{IH} or V _{IL} | -0.05 | 4.5 | 4.4 | - | 4.4 | - | 4.4 | - | V |
| | | | -24 | 4.5 | 3.94 | - | 3.8 | - | 3.7 | - | V |
| | | | -75 (Note 6, 7) | 5.5 | - | - | 3.85 | - | - | - | V |
| | | | -50 (Note 6, 7) | 5.5 | - | - | - | - | 3.85 | - | V |
| Low Level Output Voltage | V_{OL} | V _{IH} or V _{IL} | 0.05 | 4.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 24 | 4.5 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 75 (Note 6, 7) | 5.5 | - | - | - | 1.65 | - | - | V |
| | | | 50 (Note 6, 7) | 5.5 | - | - | - | - | - | 1.65 | V |
| Input Leakage Current | IĮ | V _{CC} or GND | - | 5.5 | - | ±0.1 | - | ±1 | - | ±1 | μА |
| Quiescent Supply Current MSI | Icc | V _{CC} or GND | 0 | 5.5 | - | 8 | - | 80 | - | 160 | μА |
| Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load | Δl _{CC} | V _{CC} -2.1 | - | 4.5 to 5.5 | - | 2.4 | - | 2.8 | - | 3 | mA |

NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum 50Ω transmission-line-drive capability at 85° C, 75Ω at 125° C.

ACT Input Load Table

| INPUT | UNIT LOAD |
|-----------------|-----------|
| A0, B0, A2, B2 | 1.66 |
| A1, B1 | 1.9 |
| A3, B3 | 1.4 |
| C _{IN} | 1.1 |

NOTE: Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25 $^{\rm o}$ C.

Switching Specifications Input t_r , t_f = 3ns, C_L = 50pF (Worst Case)

| | | | -40 ⁰ | C TO 85 ⁰ | С | -55 | °C TO 12 | 5°C | |
|--|-------------------------------------|---------------------|------------------|----------------------|------|-----|----------|------|-------|
| PARAMETER | SYMBOL | V _{CC} (V) | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| AC TYPES | | | | | | | | | |
| Propagation Delay, | t _{PLH} , t _{PHL} | 1.5 | - | - | 199 | - | - | 219 | ns |
| An or Bn to C _{OUT} C _{IN} to Sn C _{IN} to C _{OUT} | | 3.3 (Note 9) | 6.3 | - | 22.4 | 6.2 | - | 24.6 | ns |
| | | 5 (Note 10) | 4.5 | - | 16 | 4.4 | - | 17.6 | ns |
| Propagation Delay, | t _{PLH} , t _{PHL} | 1.5 | - | - | 207 | - | - | 228 | ns |
| An or Bn to Sn | | 3.3 | 6.6 | - | 23.2 | 6.4 | - | 25.5 | ns |
| | | 5 | 4.7 | - | 16.5 | 4.6 | - | 18.2 | ns |
| Input Capacitance | Cl | - | - | - | 10 | - | - | 10 | pF |
| Power Dissipation Capacitance | C _{PD} (Note 11) | - | - | 120 | - | - | 120 | - | pF |
| ACT TYPES | | | | | | | | • | • |
| Propagation Delay, An or Bn to C _{OUT} C _{IN} to Sn C _{IN} to C _{OUT} | t _{PLH} , t _{PHL} | 5 (Note 10) | 4.5 | - | 16 | 2.7 | - | 17.6 | ns |
| Propagation Delay, An or Bn to Sn | t _{PLH} , t _{PHL} | 5 | 4.7 | - | 16.5 | 3.3 | - | 18.2 | ns |
| Input Capacitance | Cl | - | - | - | 10 | - | - | 10 | pF |
| Power Dissipation Capacitance | C _{PD} (Note 11) | - | - | 120 | - | - | 120 | - | pF |

NOTES:

- 8. Limits tested 100%.
- 9. 3.3V Min is at 3.6V, Max is at 3V.
- 10. 5V Min is at 5.5V, Max is at 4.5V.

11. C_{PD} is used to determine the dynamic power consumption per function. AC: $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ ACT: $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$ where f_i = input frequency, C_L = output load capacitance, V_{CC} = supply voltage.

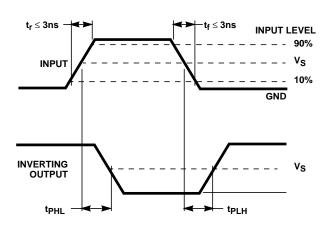
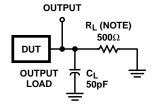


FIGURE 1. PROPAGATION DELAY TIMES



NOTE: For AC Series Only: When V_{CC} = 1.5V, R_L = 1k Ω .

| | AC | ACT |
|--|---------------------|---------------------|
| Input Level | V _{CC} | 3V |
| Input Switching Voltage, V _S | 0.5 V _{CC} | 1.5V |
| Output Switching Voltage, V _S | 0.5 V _{CC} | 0.5 V _{CC} |

FIGURE 2. PROPAGATION DELAY TIMES



www.ti.com 28-Aug-2024

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|----------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|----------------------|---------|
| CD54AC283F3A | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | CD54AC283F3A | Samples |
| CD54ACT283F3A | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | CD54ACT283F3A | Samples |
| CD74AC283E | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -55 to 125 | CD74AC283E | Samples |
| CD74AC283M | OBSOLETI | E SOIC | D | 16 | | TBD | Call TI | Call TI | -55 to 125 | AC283M | |
| CD74AC283M96 | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AC283M | Samples |
| CD74ACT283E | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -55 to 125 | CD74ACT283E | Samples |
| CD74ACT283EE4 | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -55 to 125 | CD74ACT283E | Samples |
| CD74ACT283M | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | ACT283M | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

PACKAGE OPTION ADDENDUM

www.ti.com 28-Aug-2024

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF CD54AC283, CD54ACT283, CD74AC283, CD74ACT283:

Catalog: CD74AC283, CD74ACT283

Military: CD54AC283, CD54ACT283

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 19-Apr-2024

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

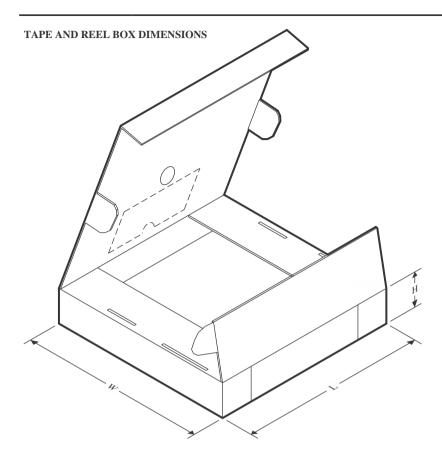


*All dimensions are nominal

| Device | U | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74AC283M96 | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |

PACKAGE MATERIALS INFORMATION

www.ti.com 19-Apr-2024



*All dimensions are nominal

| Ì | Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ı | CD74AC283M96 | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |

PACKAGE MATERIALS INFORMATION

www.ti.com 19-Apr-2024

TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) | | |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|--|--|
| CD74AC283E | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74AC283E | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74ACT283E | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74ACT283E | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74ACT283EE4 | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74ACT283EE4 | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| CD74ACT283M | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 | | |

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated